



ocket No.: HSI-0003

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of :  
Ki-Dong KIM, Sang-Dae KIM, Yoon-Soo HAN, :  
Yoon-Heung TAK, Dong-Uk KIM, Tae-Jeong KIM, :  
Ung-Chan YOON, Sung-Hoon KIM, and :  
Hee-Wan MOON :  
:  
Serial No.: 10/724,766 :  
Confirm. No.: Unassigned :  
Filed: December 2, 2003 : Customer No.: 34610

For: PHENYL PYRIDINE-IRIDIUM METAL COMPLEX COMPOUNDS FOR  
ORGANIC ELECTROLUMINESCENT DEVICE, PROCESS FOR  
PREPARING THE COMPOUNDS, AND ORGANIC  
ELECTROLUMINESCENT DEVICE USING THE COMPOUNDS

**SUBMISSION OF SUBSTITUTE DECLARATION**  
**AND POWER OF ATTORNEY**

U.S. Patent and Trademark Office  
2011 South Clark Place  
Customer Window  
Crystal Plaza Two, Lobby, Room 1B03  
Arlington, Virginia 22202

Sir:

Enclosed is a Substitute Declaration for the above-identified application in support of amendments made to the application in the Preliminary Amendment filed December 2, 2003.

If any fees are required, please charge them to Deposit Account No. 16-0607 and advise the undersigned accordingly.

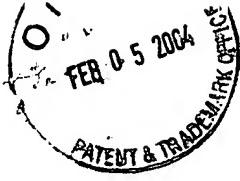
Respectfully submitted,  
FLESHNER & KIM, LLP

Donald R. McPhail  
Registration No. 35,811

P.O. Box 221200  
Chantilly, Virginia 20153-1200  
703 766-3701

Date: February 5, 2004

Please direct all correspondence to Customer Number 34610



Docket No.: HSI-0003

## DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

My residence, post office and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter claimed and for which a patent is sought on the invention entitled PHENYL PYRIDINE-IRIDIUM METAL COMPLEX COMPOUNDS FOR ORGANIC ELECTROLUMINESCENT DEVICE, PROCESS FOR PREPARING THE COMPOUNDS, AND ORGANIC ELECTROLUMINESCENT DEVICE USING THE COMPOUNDS, the specification of which

[ ] is attached hereto       was filed on December 2, 2003 as Application Serial No. 10/724,766 and was amended on December 2, 2003 (if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is known to me to be material to patentability in accordance with Title 37, Code of Federal Regulations, Section 1.56(a).

I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or 365 (b) of any foreign application(s) for patent or inventor's certificate, or 365(a) of any PCT international application which designated at least one country other than the United States of America, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or of any PCT international application having a filing date before that of the application on which priority is claimed.

Prior Foreign Application(s): <u>Number</u>	<u>Country</u>	Foreign Filing Date <u>Month/Day/Year</u>
2002-76208	Republic of Korea	December 3, 2002

I hereby claim the benefit under 35 U.S.C. 119(e) of any United States provisional application(s) listed below.

<u>Application Number(s):</u>	<u>Filing Date (Month/Day/Year)</u>

I hereby claim the benefit under 35 U.S.C. 120 of any United States application(s), or 365(c) of any PCT international application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application in the manner provided by the first paragraph of 35 U.S.C. 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

<u>Prior U. S. Application or PCT Parent Number</u>	<u>Filing Date (Month/Day/Year)</u>	<u>Parent Patent Number (if applicable)</u>

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

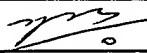
I hereby appoint the following attorney(s) and/or agent(s): Daniel Y. J. Kim, Registration No. 36,186; Mark L. Fleshner, Registration No. 34,596; Carl R. Wesolowski, Registration No. 40,372; John C. Eisenhart, Registration No. 38,128; Donald R. McPhail, Registration No. 35,811; Rene A. Vazquez, Registration No. 38,647; Carol L. Druzbick, Registration No. 40,287; Laura L. Lee, Registration No. 48,752; Timothy M. Speer, Registration No. 47,355; Samuel W. Ntiros, Registration No. 39,318; Daniel H. Sherr, Registration No. 46,425; John L. Ciccozzi, Registration No. 48,984; Steven J. Helmer, Registration No. 40,475; Mark E. Olds, Registration No. 46,507; and David C. Oren, Registration No. 38,694, all of

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with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith, and all future correspondence should be addressed to them.

\*\*\*\*\*

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Inventor's signature: 

Date: December 10, 2003

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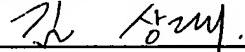
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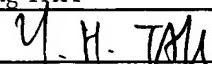
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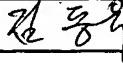
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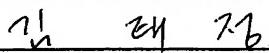
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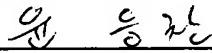
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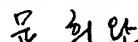
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